

PCN Number:	20130723002			PCN Date:	07/25/2013
Title:	TPS40200-Q1 datasheet - CMS C1307014				
Customer Contact:	PCN Manager	Phone:	+1(214) 480-6037	Dept:	Quality Services
Change Type:					
<input type="checkbox"/>	Assembly Site	<input type="checkbox"/>	Assembly Process	<input type="checkbox"/>	Assembly Materials
<input type="checkbox"/>	Design	<input checked="" type="checkbox"/>	Electrical Specification	<input type="checkbox"/>	Mechanical Specification
<input type="checkbox"/>	Test Site	<input type="checkbox"/>	Packing/Shipping/Labeling	<input type="checkbox"/>	Test Process
<input type="checkbox"/>	Wafer Bump Site	<input type="checkbox"/>	Wafer Bump Material	<input type="checkbox"/>	Wafer Bump Process
<input type="checkbox"/>	Wafer Fab Site	<input type="checkbox"/>	Wafer Fab Materials	<input type="checkbox"/>	Wafer Fab Process

PCN Details	
Description of Change:	
Texas Instruments publication SLUS739 has changed as described below: Changes from Revision D (July 2011) to Revision E: Page 3, Deleted T _A test condition and values from Feedback voltage parameter in ELECTRICAL CHARACTERISTICS table	
Reason for Change:	
Remove redundant test condition.	
Anticipated impact on Fit, Form, Function, Quality or Reliability (positive / negative):	
No anticipated impact. This is a specification change announcement only. There are no changes to the actual device.	
Changes to product identification resulting from this PCN:	
None	
Product Affected:	
TPS40200QDRQ1	

For questions regarding this notice, e-mails can be sent to the regional contacts shown below or your local Field Sales Representative.

Location	E-Mail
USA	PCNAmericasContact@list.ti.com
Europe	PCNEuropeContact@list.ti.com
Asia Pacific	PCNAsiaContact@list.ti.com
Japan	PCNJapanContact@list.ti.com